

## Dual N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY				
	$V_{DS}$ (V)	$r_{DS(on)}$ ( $\Omega$ )	$I_D$ (A) <sup>a</sup>	$Q_g$ (Typ)
N-Channel	40	0.039 at $V_{GS} = 10$ V	6.6	6.6
		0.050 at $V_{GS} = 4.5$ V	5.8	

### FEATURES

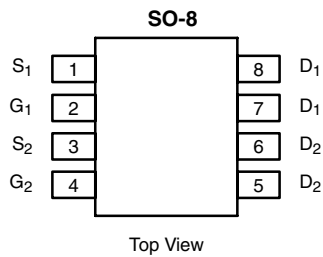
- TrenchFET<sup>®</sup> Power MOSFET
- 100 %  $R_g$  and UIS tested



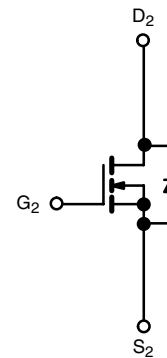
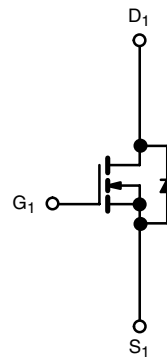
RoHS  
COMPLIANT

### APPLICATIONS

- CCFL Inverter



Ordering Information: Si4906DY-T1-E3 (Lead (Pb)-free)



ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted				
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	$V_{DS}$	40	V	
Gate-Source Voltage	$V_{GS}$	$\pm 16$		
Continuous Drain Current ( $T_J = 150$ °C)	$I_D$	$T_C = 25$ °C	6.6	A
		$T_C = 70$ °C	5.3	
		$T_A = 25$ °C	5.3 <sup>b, c</sup>	
		$T_A = 70$ °C	4.2 <sup>b, c</sup>	
Pulsed Drain Current (10 $\mu$ s Pulse Width)	$I_{DM}$	30	A	
Source-Drain Current Diode Current	$I_S$	$T_C = 25$ °C		
		$T_A = 25$ °C	1.7 <sup>b, c</sup>	
Pulsed Source-Drain Current	$I_{SM}$	30	mJ	
Single Pulse Avalanche Current	$I_{AS}$	13		
Single-Pulse Avalanche Energy	$E_{AS}$	8.5		
Maximum Power Dissipation	$P_D$	$T_C = 25$ °C	3.1	W
		$T_C = 70$ °C	2	
		$T_A = 25$ °C	2 <sup>b, c</sup>	
		$T_A = 70$ °C	1.28 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 50 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit		Unit	
		Typical	Maximum		
Maximum Junction-to-Ambient <sup>b, d</sup>	$R_{thJA}$	52	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	$R_{thJF}$	32	40		

Notes:

- Based on  $T_C = 25$  °C.
- Surface Mounted on 1" x 1" FR4 board.
- $t = 10$  sec.
- Maximum under Steady State conditions is 110 °C/W.

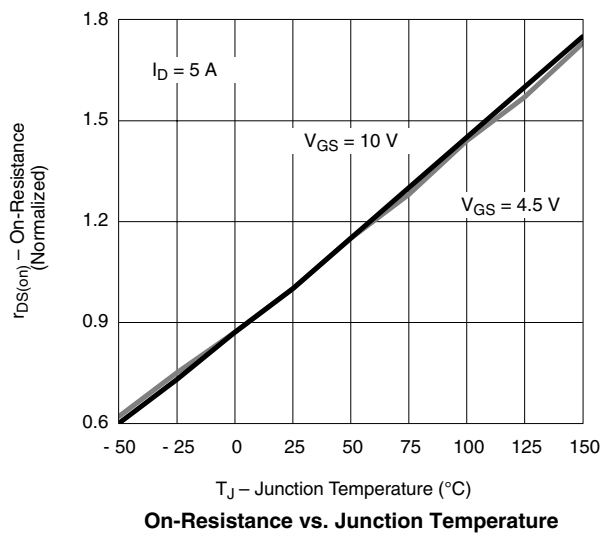
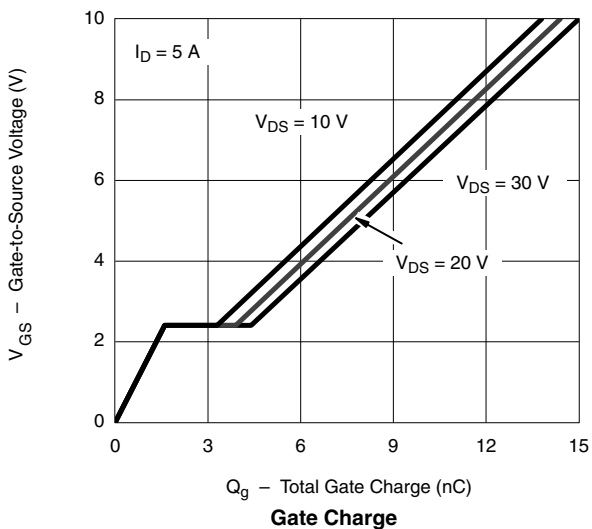
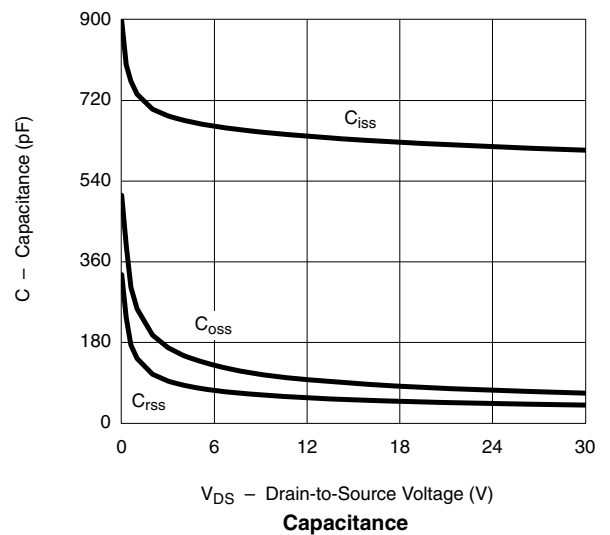
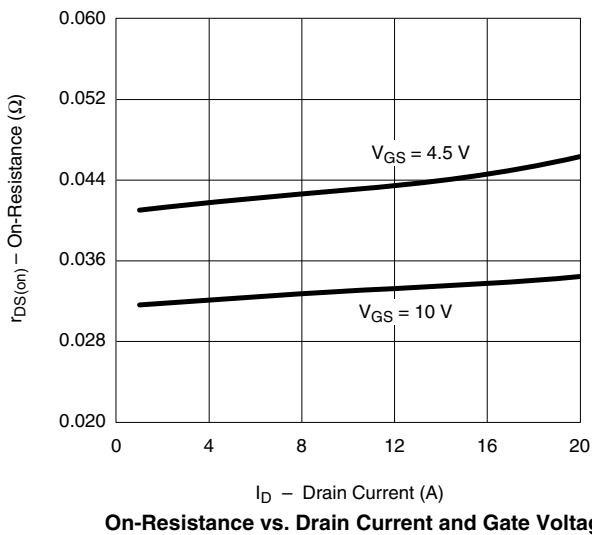
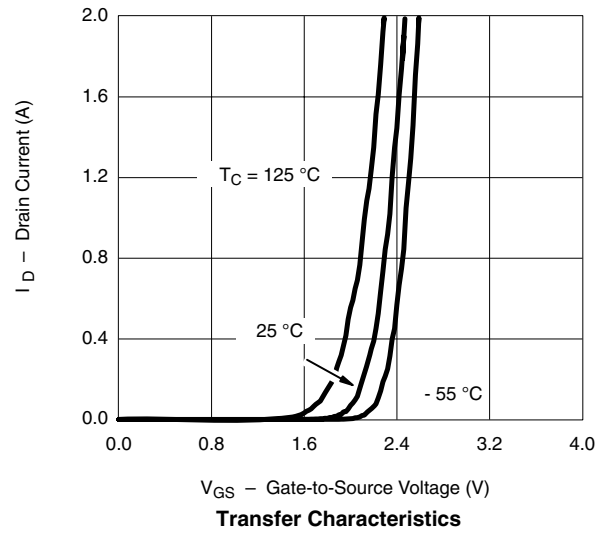
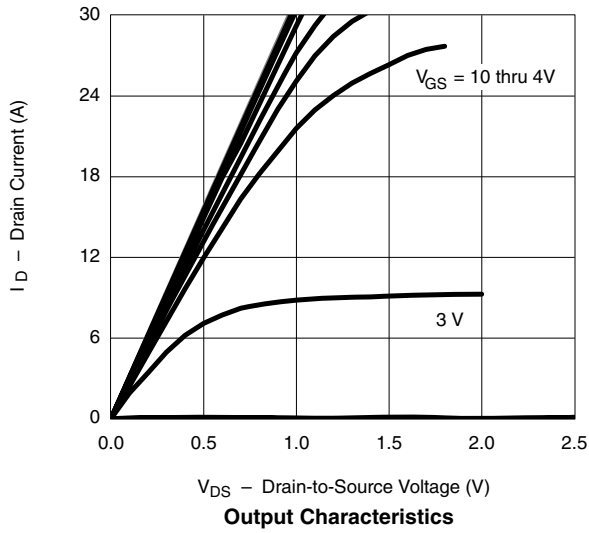
<b>SPECIFICATIONS</b> $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted						
Parameter	Symbol	Test Conditions	Min	Typ <sup>a</sup>	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$	40			V
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250\text{ }\mu\text{A}$		40		
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			-4.6		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$	0.8		2.2	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 16\text{ V}$			100	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 40\text{ V}$ , $V_{GS} = 0\text{ V}$			1	$\mu\text{A}$
		$V_{DS} = 40\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 55\text{ }^\circ\text{C}$			10	
On-State Drain Current <sup>b</sup>	$I_{D(on)}$	$V_{DS} = 5\text{ V}$ , $V_{GS} = 10\text{ V}$	20			A
Drain-Source On-State Resistance <sup>b</sup>	$r_{DS(on)}$	$V_{GS} = 10\text{ V}$ , $I_D = 5\text{ A}$		0.032	0.039	$\Omega$
		$V_{GS} = 4.5\text{ V}$ , $I_D = 4\text{ A}$		0.041	0.050	
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = 15\text{ V}$ , $I_D = 5\text{ A}$		15		S
<b>Dynamic<sup>a</sup></b>						
Input Capacitance	$C_{iss}$	N-Channel $V_{DS} = 20\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1\text{ MHz}$		625		pF
Output Capacitance	$C_{oss}$			88		
Reverse Transfer Capacitance	$C_{rss}$			50		
Total Gate Charge	$Q_g$	$V_{DS} = 20\text{ V}$ , $V_{GS} = 10\text{ V}$ , $I_D = 5\text{ A}$		14.4	22	nC
		N-Channel $V_{DS} = 20\text{ V}$ , $V_{GS} = 4.5\text{ V}$ , $I_D = 5\text{ A}$		6.6	10	
$Q_{gs}$			1.6			
$Q_{gd}$			2.3			
Gate Resistance	$R_g$	$f = 1\text{ MHz}$		2.3	3.5	$\Omega$
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20\text{ V}$ , $R_L = 4\text{ }\Omega$ $I_D \cong 5\text{ A}$ , $V_{GEN} = 10\text{ V}$ , $R_g = 1\text{ }\Omega$		9	15	ns
Rise Time	$t_r$			51	77	
Turn-Off Delay Time	$t_{d(off)}$			21	32	
Fall Time	$t_f$			6	10	
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20\text{ V}$ , $R_L = 4\text{ }\Omega$ $I_D \cong 5\text{ A}$ , $V_{GEN} = 4.5\text{ V}$ , $R_g = 1\text{ }\Omega$		13	20	
Rise Time	$t_r$			85	128	
Turn-Off Delay Time	$t_{d(off)}$			17	26	
Fall Time	$t_f$			7	11	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25\text{ }^\circ\text{C}$			2.5	A
Pulse Diode Forward Current <sup>a</sup>	$I_{SM}$				30	
Body Diode Voltage	$V_{SD}$	$I_S = 1.7\text{ A}$		0.79	1.2	V
Body Diode Reverse Recovery Time	$t_{rr}$	N-Channel $I_F = 1.7\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ , $T_J = 25\text{ }^\circ\text{C}$		30	45	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$			30	45	nC
Reverse Recovery Fall Time	$t_a$			17		ns
Reverse Recovery Rise Time	$t_b$			13		

## Notes:

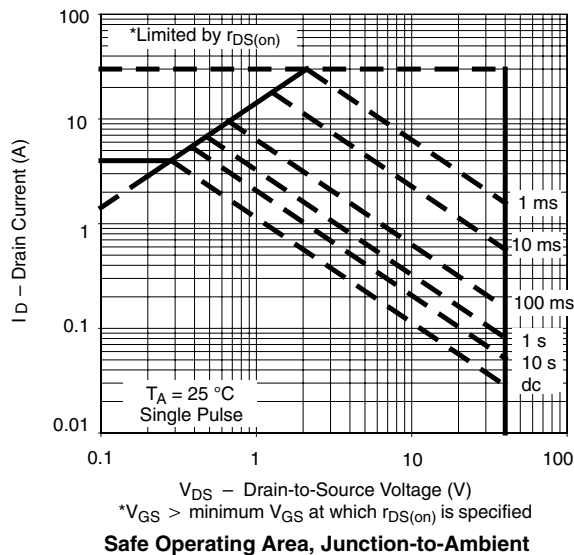
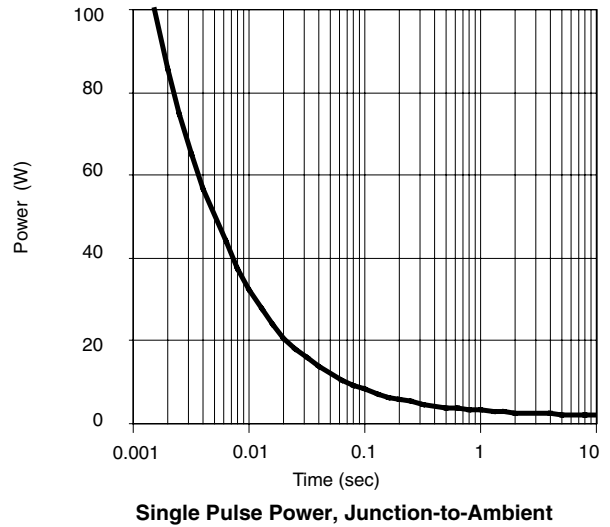
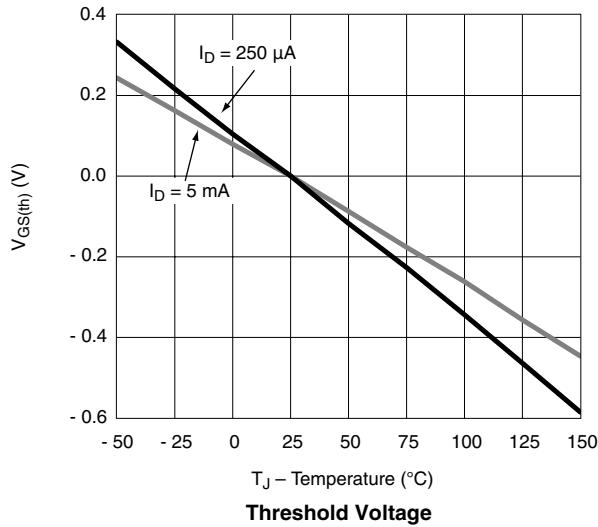
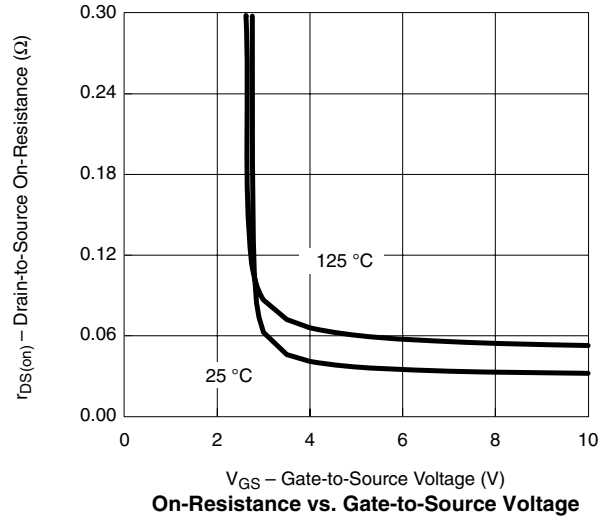
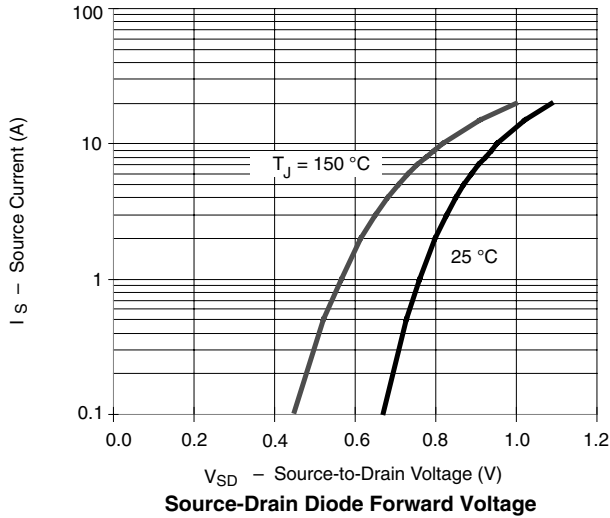
- a. Guaranteed by design, not subject to production testing.  
b. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$ .

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

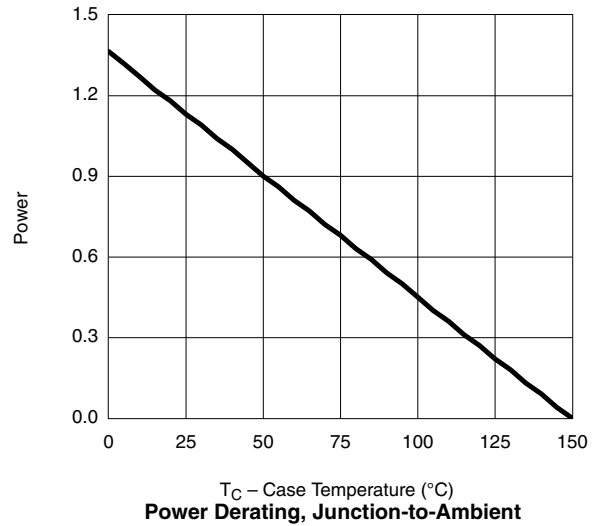
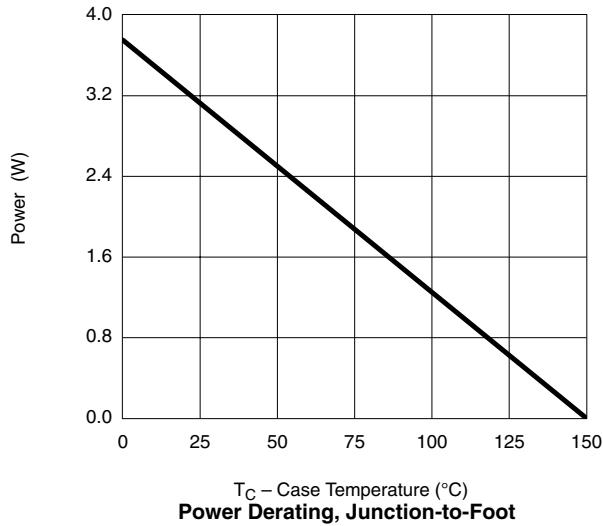
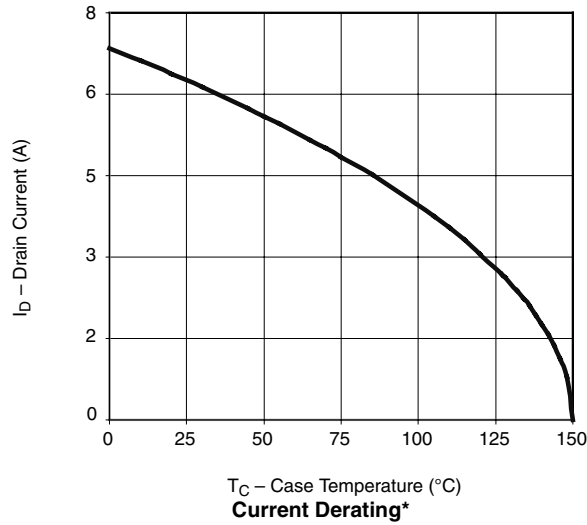
## N-CHANNEL TYPICAL CHARACTERISTICS 25 °C unless noted



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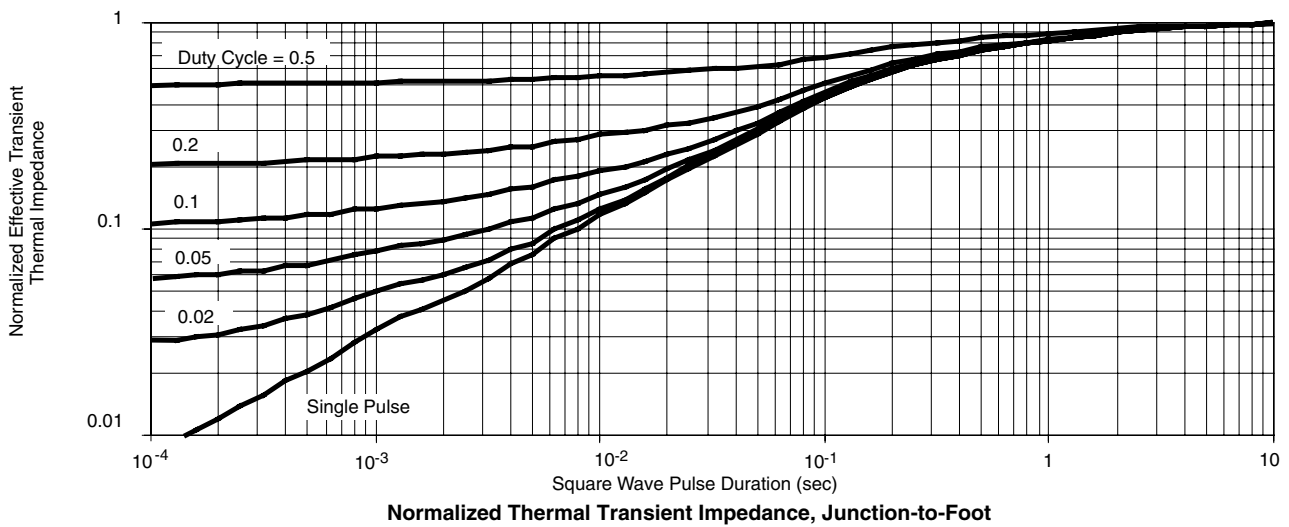
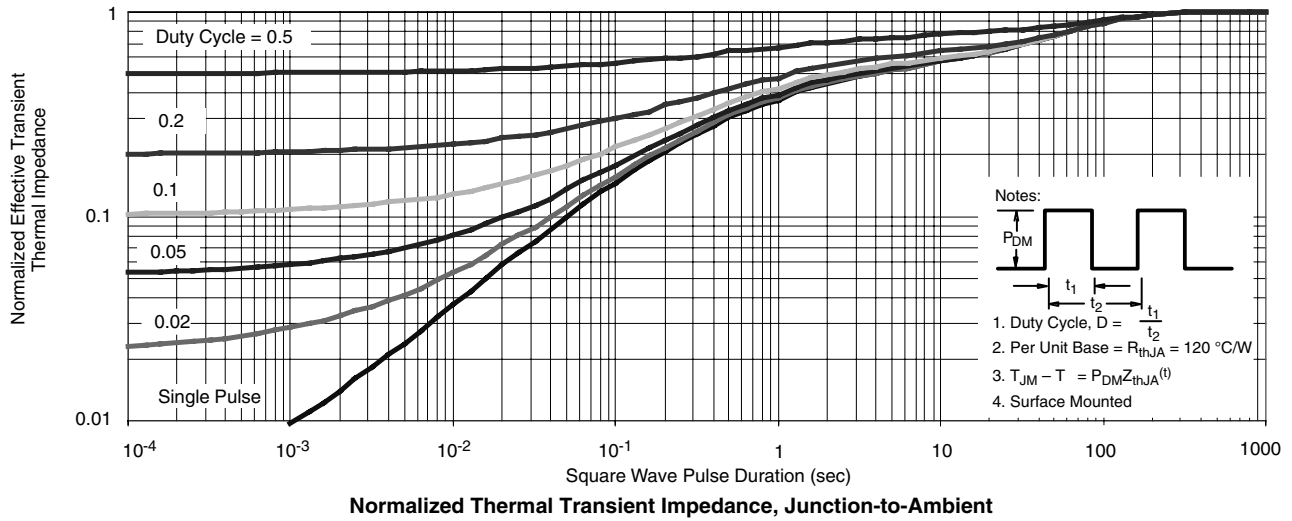


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\*The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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